PSMN4R3-30PL



N-channel 30 V 4.3 m Ω logic level MOSFET

Rev. 01 — 16 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- Suitable for logic level gate drive sources

1.3 Applications

- DC-to-DC converters
- Load switiching

- Motor control
- Server power supplies

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	-	30	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u>	[1]	-	-	100	Α
P _{tot}	total power dissipation	$T_{mb} = 25 ^{\circ}C; \text{ see } \underline{\text{Figure 2}}$		-	-	103	W
Dynamic	characteristics						
Q_{GD}	gate-drain charge	V_{GS} = 4.5 V; I_D = 25 A; V_{DS} = 15 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	5	-	nC
Static ch	Static characteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 13}{}$	[2]	-	3.5	4.3	mΩ

^[1] Continuous current is limited by package.



^[2] Measured 3 mm from package.

2. Pinning information

Table 2. Pinning information

Symbol	Description	Simplified outline	Graphic symbol
G	gate		_
D	drain	mb	D
S	source		$G \longrightarrow A$
D	mounting base; connected to drain	1 2 3	mbb076 S
		SOT78 (TO-220AB;SC-46)	
	G D S	G gate D drain S source D mounting base; connected to	G gate D drain S source D mounting base; connected to drain

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMN4R3-30PL	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

Limiting values

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
-				141111		
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	30	V
V_{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	30	V
V_{GS}	gate-source voltage			-20	20	V
I _D	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 100 \text{ °C}; \text{ see } \frac{\text{Figure 1}}{\text{Model}}$	[1]	-	80	Α
		V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	Α
I_{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see <u>Figure 3</u>		-	465	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	103	W
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dra	ain diode					
Is	source current	T _{mb} = 25 °C	[1]	-	100	Α
I _{SM}	peak source current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C		-	465	Α
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 100 A; V_{sup} ≤ 30 V; R_{GS} = 50 Ω; unclamped		-	74	mJ

[1] Continuous current is limited by package.

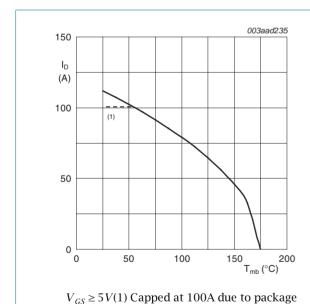
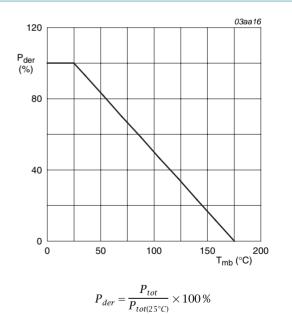
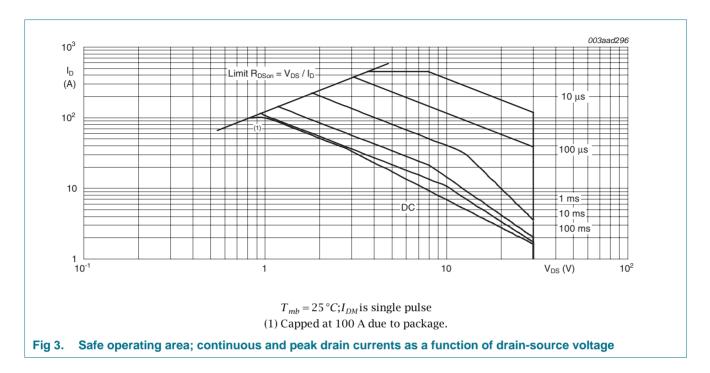


Fig 1. Continuous drain current as a function of mounting base temperature



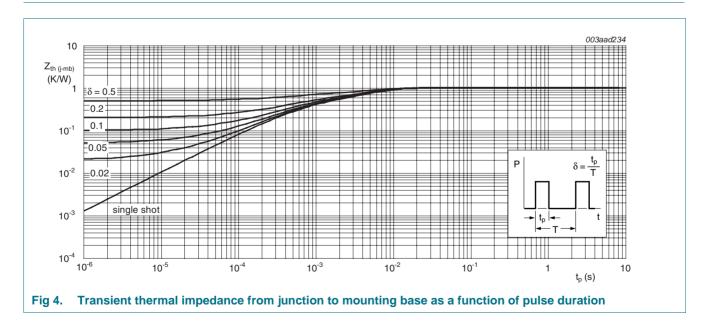
Normalized total power dissipation as a Fig 2. function of mounting base temperature



5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	N	/lin	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <u>Figure 4</u>	-		1	1.5	K/W



6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
$V_{(BR)DSS}$	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$		30	-	-	V
	breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = -55 °C$		27	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS} ; T_j = 25 °C; see <u>Figure 10</u> ; see <u>Figure 11</u>		1.3	1.7	2.15	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 175$ °C; see Figure 11		0.5	-	-	V
		I_D = 1 mA; V_{DS} = V_{GS} ; T_j = -55 °C; see <u>Figure 11</u>		-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	1	μΑ
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	40	μΑ
I _{GSS}	gate leakage current	$V_{GS} = 16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
		$V_{GS} = -16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R _{DSon}	drain-source on-state	$V_{GS} = 4.5 \text{ V}; I_D = 15 \text{ A}; T_j = 25 \text{ °C}$	[2]	-	4.5	6.2	mΩ
	resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>		-	-	6	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A}; T_j = 25 \text{ °C};$ see Figure 13;	[2]	-	3.5	4.3	mΩ
R _G	gate resistance	f = 1 MHz		-	1	-	Ω
Dynamic	characteristics						
Q _{G(tot)} total gate charge	total gate charge	I_D = 25 A; V_{DS} = 15 V; V_{GS} = 4.5 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	19	-	nC
		$I_D = 25 \text{ A}$; $V_{DS} = 15 \text{ V}$; $V_{GS} = 10 \text{ V}$; see Figure 14; see Figure 15		-	41.5	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$		-	8	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 14</u> ; see <u>Figure 15</u>		-	4	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	4	-	nC
Q_{GD}	gate-drain charge			-	5	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	V _{DS} = 15 V; see <u>Figure 14</u> ; see <u>Figure 15</u>		-	2.7	-	V
C _{iss}	input capacitance	$V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$		-	2400	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 16</u>		-	500	-	pF
C _{rss}	reverse transfer capacitance			-	240	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 20 \text{ V}; R_L = 0.5 \Omega; V_{GS} = 10 \text{ V};$		-	28	-	ns
t _r	rise time	$R_{G(ext)} = 5.6 \Omega$		-	58	-	ns
t _{d(off)}	turn-off delay time			-	44	-	ns
V- /	fall time						

Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-dr	ain diode					
V_{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C};$ see <u>Figure 17</u>	-	0.81	1.2	V
t _{rr}	reverse recovery time	$I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$; $V_{GS} = 0 \text{ V}$;	-	35	-	ns
Qr	recovered charge	$V_{DS} = 30 \text{ V}$	-	30	-	nC

- [1] Tested to JEDEC standards where applicable.
- [2] Measured 3 mm from package.

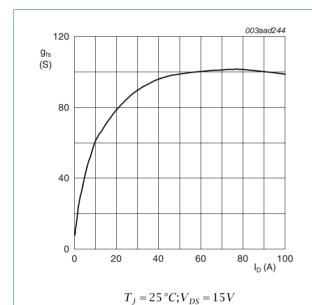


Fig 5. Forward transconductance as a function of drain current; typical values

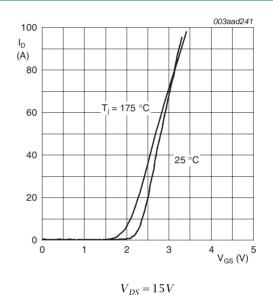
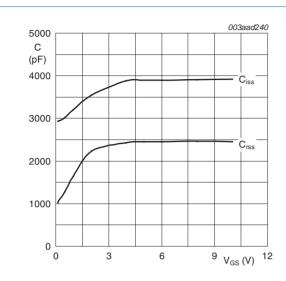
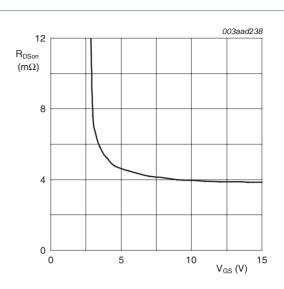


Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values



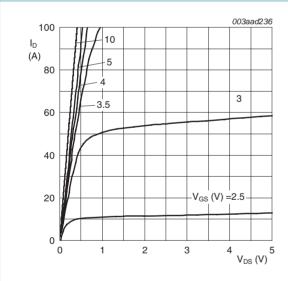
 $V_{DS} = 0\,V; f = 1MHz$

Fig 7. Input and reverse transfer capacitances as a function of gate-source voltage; typical values



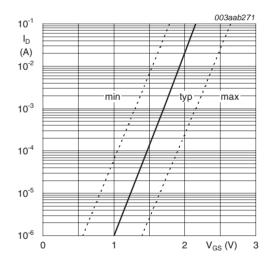
$$T_j = 25 \,{}^{\circ}C; I_D = 15A$$

Fig 8. Drain-source on-state resistance as a function of gate-source voltage; typical values



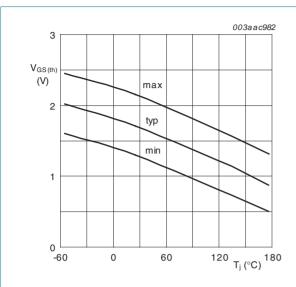
 $T_j = 25 \, {}^{\circ}C; t_p = 300 \, \mu s$

Fig 9. Output characteristics: drain current as a function of drain-source voltage; typical values



$$T_j = 25 \,^{\circ}C; V_{DS} = 5 \, V$$

Fig 10. Sub-threshold drain current as a function of gate-source voltage



 $I_D=1\, mA; V_{DS}=V_{GS}$

Fig 11. Gate-source threshold voltage as a function of junction temperature

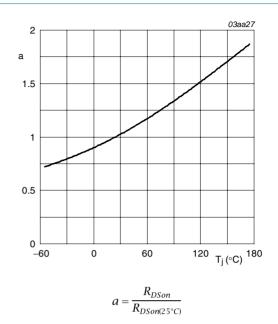
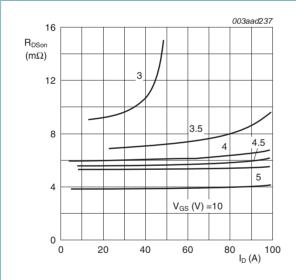


Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature



 $T_i = 25 \, ^{\circ}C; t_p = 300 \, \mu s$

Fig 13. Drain-source on-state resistance as a function of drain current; typical values

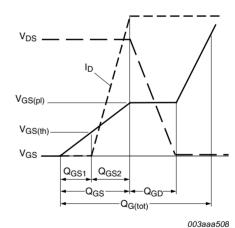


Fig 14. Gate charge waveform definitions

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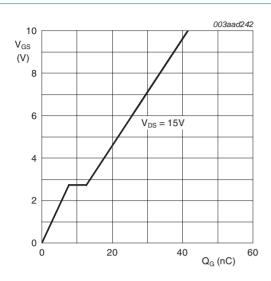
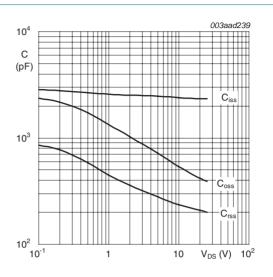


Fig 15. Gate-source voltage as a function of gate charge; typical values

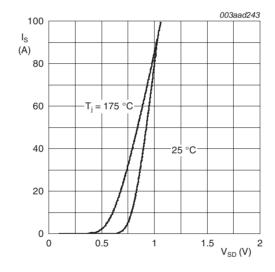
 $T_j = 25 \,^{\circ}C; I_D = 25A$



$$V_{GS} = 0V; f = 1MHz$$

Fig 16. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

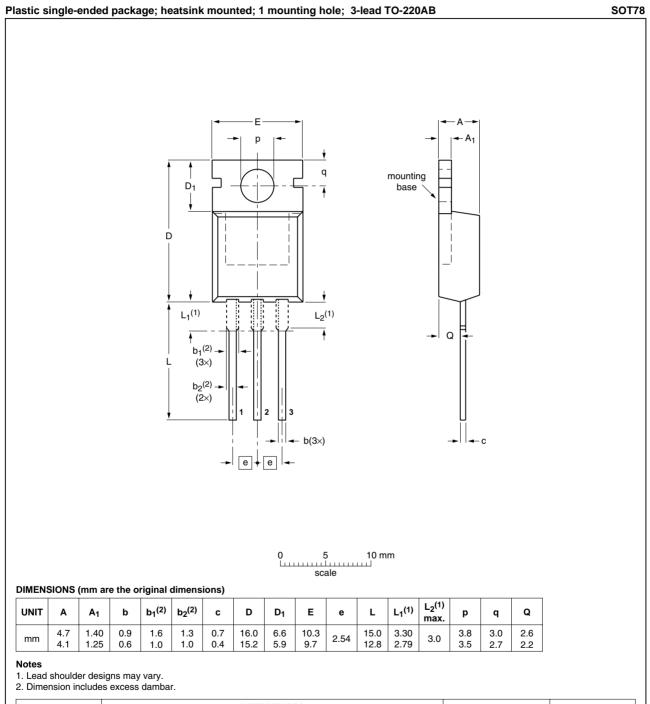
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 $V_{GS} = 0V$

Fig 17. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

7. Package outline



OUTLINE		REFERENCES			EUROPEAN	ISSUE DATE	
VEI	RSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
S	OT78		3-lead TO-220AB	SC-46			08-04-23 08-06-13

Fig 18. Package outline SOT78 (TO-220AB)

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N-channel 30 V 4.3 m Ω logic level MOSFET

Revision history

Table 7. **Revision history**

Product data sheet

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN4R3-30PL_1	20090616	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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